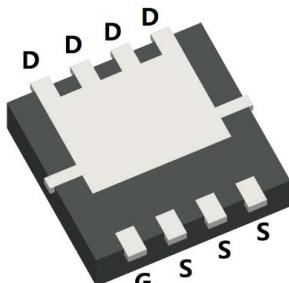
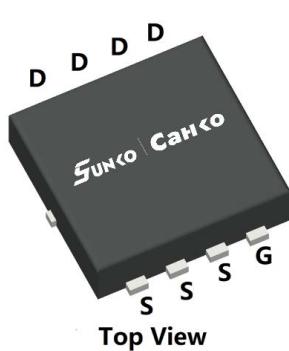
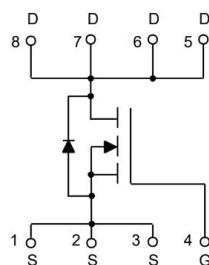


N-Channel Enhancement Mode Field Effect Transistor

Top View

Bottom View

PDFN3333-8L**Product Summary**

- V_{DS} 100V
- I_D 10A
- $R_{DS(ON)}$ (at $V_{GS}=10V$) $<120m\Omega$
- $R_{DS(ON)}$ (at $V_{GS}=4.5V$) $<130m\Omega$
- 100% EAS Tested
- 100% ∇V_{DS} Tested

General Description

- Trench Power MV MOSFET technology
- Excellent package for heat dissipation
- High density cell design for low $R_{DS(ON)}$
- Moisture Sensitivity Level 1
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

Applications

- Power management functions
- DC-DC convertor

Absolute Maximum Ratings ($T_J=25^\circ C$ unless otherwise noted)

| Parameter | | | Symbol | Limit | Unit |
|---|--|-------------------|----------------|----------|------|
| Drain-source Voltage | | | V_{DS} | 100 | V |
| Gate-source Voltage | | | V_{GS} | ± 20 | V |
| Continuous Drain Current (Note 1,2) | Steady-State | $T_A=25^\circ C$ | I_D | 2.6 | A |
| | | $T_A=100^\circ C$ | | 1.8 | |
| Continuous Drain Current (Note 1,3) | Steady-State | $T_C=25^\circ C$ | | 10 | A |
| | | $T_C=100^\circ C$ | | 7 | |
| Pulsed Drain Current | $T_C=25^\circ C, t_p=100\mu s$ | | I_{DM} | 25 | A |
| Avalanche energy | $V_G=10V, R_G=25\Omega, L=0.5mH, IAS=8.5A$ | | EAS | 18 | mJ |
| Total Power Dissipation (Note 1,2) | Steady-State | $T_A=25^\circ C$ | P_D | 2.5 | W |
| | | $T_A=100^\circ C$ | | 1.25 | |
| Total Power Dissipation (Note 1,3) | Steady-State | $T_C=25^\circ C$ | | 35 | |
| | | $T_C=100^\circ C$ | | 17 | |
| Junction and Storage Temperature Range | | | T_J, T_{STG} | -55~+175 | °C |

Thermal resistance

| Parameter | | Symbol | Typ | Max | Units |
|---|--------------|-----------------|-----|-----|-------|
| Thermal Resistance Junction-to-Ambient (Note 2) | Steady-State | $R_{\theta JA}$ | 50 | 60 | °C/W |
| Thermal Resistance Junction-to-Case | Steady-State | $R_{\theta JC}$ | 3.5 | 4.2 | |

Ordering Information (Example)

| PREFERRED P/N | PACKING CODE | Marking | MINIMUM PACKAGE(pcs) | INNER BOX QUANTITY(pcs) | OUTER CARTON QUANTITY(pcs) | DELIVERY MODE |
|---------------|--------------|---------|----------------------|-------------------------|----------------------------|---------------|
| SCQ120N10B | F1 | Q120N10 | 5000 | 10000 | 100000 | 13" reel |

■ Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
|---------------------------------------|----------------------------|---|-----|-----|-----------|------------------|
| Static Parameter | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$ | 100 | - | - | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{\text{DS}}=100\text{V}, V_{\text{GS}}=0\text{V}$ | - | - | 1 | μA |
| | | $V_{\text{DS}}=100\text{V}, V_{\text{GS}}=0\text{V}, T_J=125^\circ\text{C}$ | - | - | 100 | |
| Gate-Body Leakage Current | I_{GSS} | $V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$ | - | - | ± 100 | nA |
| Gate Threshold Voltage | $V_{\text{GS}(\text{th})}$ | $V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$ | 1.3 | 1.8 | 2.3 | V |
| Static Drain-Source On-Resistance | $R_{\text{DS}(\text{ON})}$ | $V_{\text{GS}}=10\text{V}, I_{\text{D}}=8\text{A}$ | - | 90 | 120 | $\text{m}\Omega$ |
| | | $V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=6\text{A}$ | - | 92 | 130 | |
| Diode Forward Voltage | V_{SD} | $I_{\text{S}}=10\text{A}, V_{\text{GS}}=0\text{V}$ | - | - | 1.2 | V |
| Gate resistance | R_{G} | $f=1\text{MHz}$ | - | 3.5 | - | Ω |
| Maximum Body-Diode Continuous Current | I_{S} | | - | - | 10 | A |
| Dynamic Parameters | | | | | | |
| Input Capacitance | C_{iss} | $V_{\text{DS}}=50\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$ | - | 998 | - | pF |
| Output Capacitance | C_{oss} | | - | 28 | - | |
| Reverse Transfer Capacitance | C_{rss} | | - | 22 | - | |
| Switching Parameters | | | | | | |
| Total Gate Charge | Q_{g} | $V_{\text{GS}}=10\text{V}, V_{\text{DS}}=50\text{V}, I_{\text{D}}=10\text{A}$ | - | 19 | - | nC |
| Gate-Source Charge | Q_{gs} | | - | 3 | - | |
| Gate-Drain Charge | Q_{gd} | | - | 3.6 | - | |
| Reverse Recovery Charge | Q_{rr} | $I_{\text{F}}=10\text{A}, \text{di}/\text{dt}=100\text{A}/\text{us}$ | - | 25 | - | nC |
| Reverse Recovery Time | t_{rr} | | - | 27 | - | ns |
| Turn-on Delay Time | $t_{\text{D}(\text{on})}$ | $V_{\text{GS}}=10\text{V}, V_{\text{DD}}=50\text{V}, I_{\text{D}}=10\text{A}$ $R_{\text{GEN}}=2.2\Omega$ | - | 6.5 | - | ns |
| Turn-on Rise Time | t_{r} | | - | 21 | - | |
| Turn-off Delay Time | $t_{\text{D}(\text{off})}$ | | - | 21 | - | |
| Turn-off fall Time | t_{f} | | - | 2.2 | - | |

Note:

- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- The value of R_{GJA} is measured with the device mounted on the 40mm*40mm*1.1mm single layer FR-4 PCB board with 1 in² pad of 2oz. Copper, in the still air environment with TA =25°C. The maximum allowed junction temperature of 175°C. The value in any given application depends on the user's specific board design.
- Thermal resistance from junction to soldering point (on the exposed drain pad).

■ Typical Electrical and Thermal Characteristics Diagrams

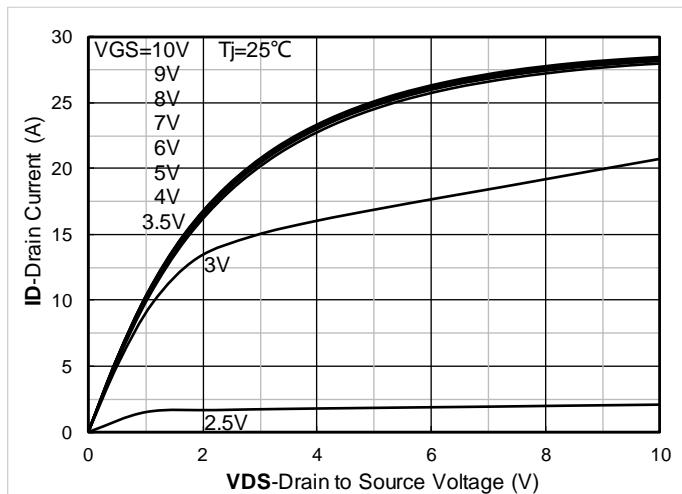


Figure 1. Output Characteristics

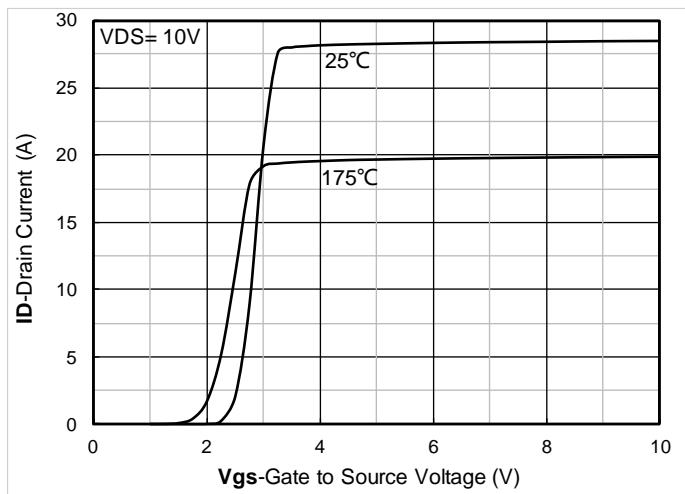


Figure 2. Transfer Characteristics

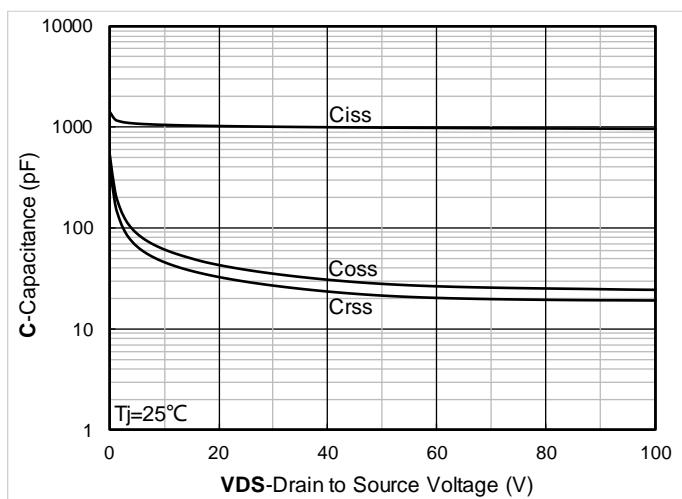


Figure 3. Capacitance Characteristics

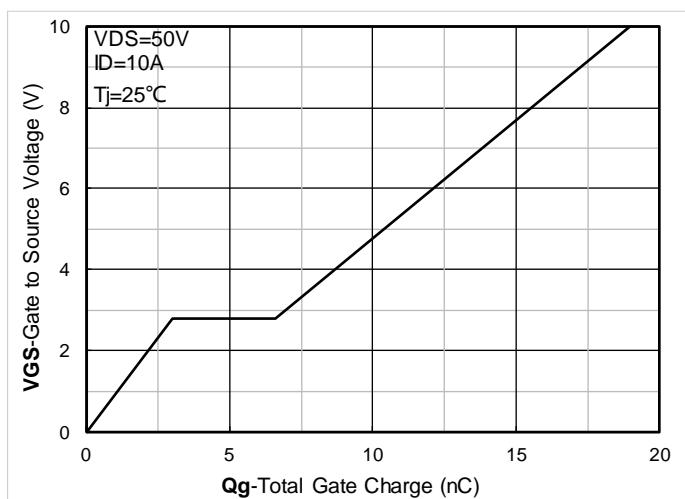


Figure 4. Gate Charge

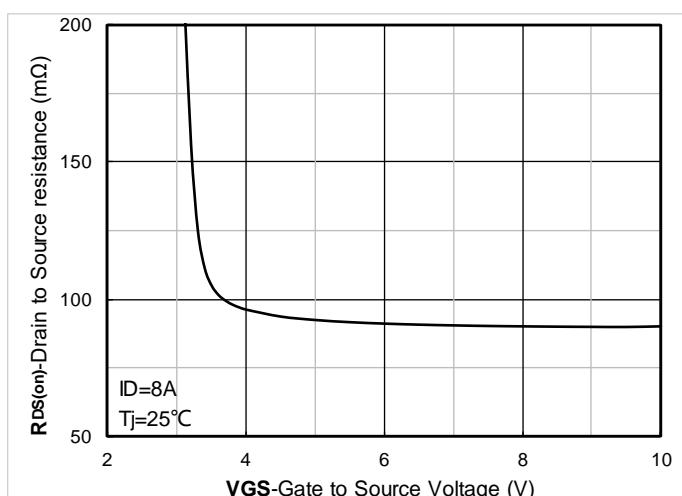


Figure 5. On-Resistance vs Gate to Source Voltage

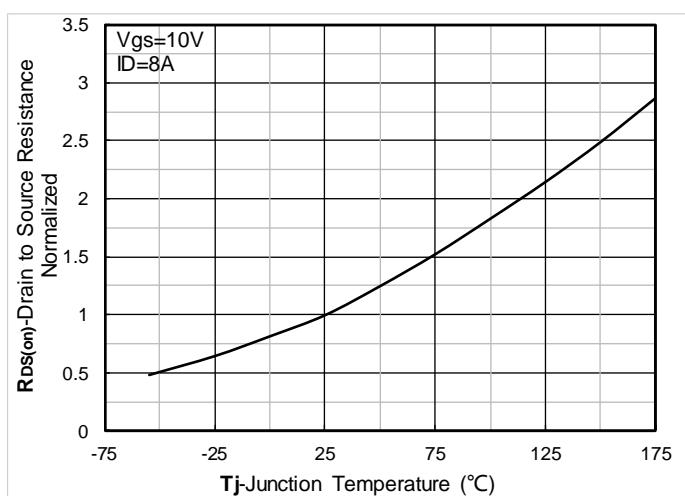


Figure 6. Normalized On-Resistance

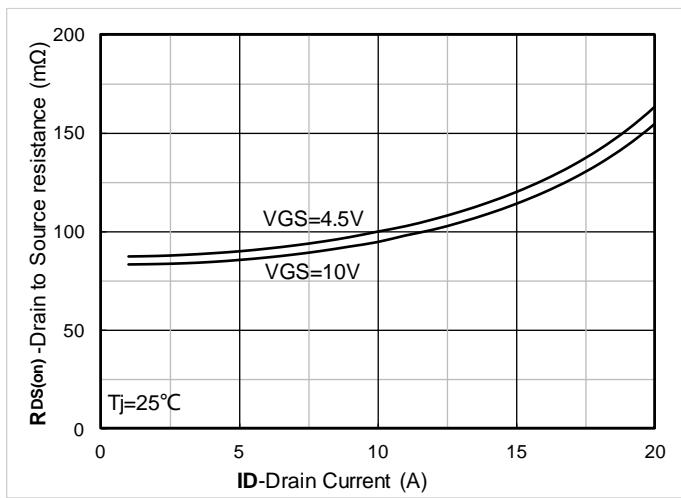


Figure 7. RDS(on) VS Drain Current

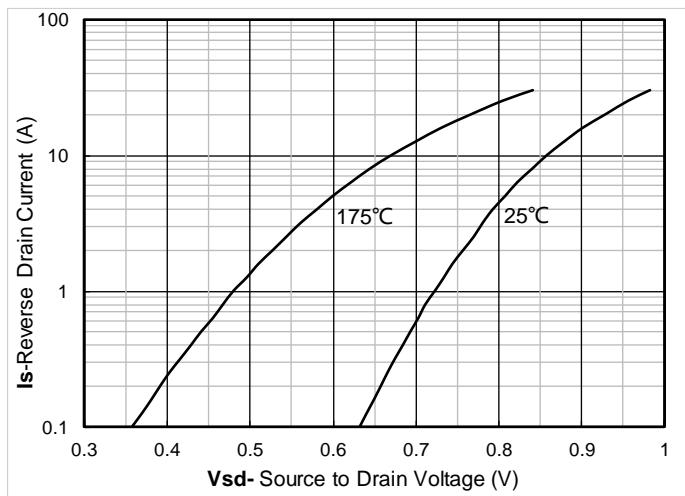


Figure 8. Forward characteristics of reverse diode

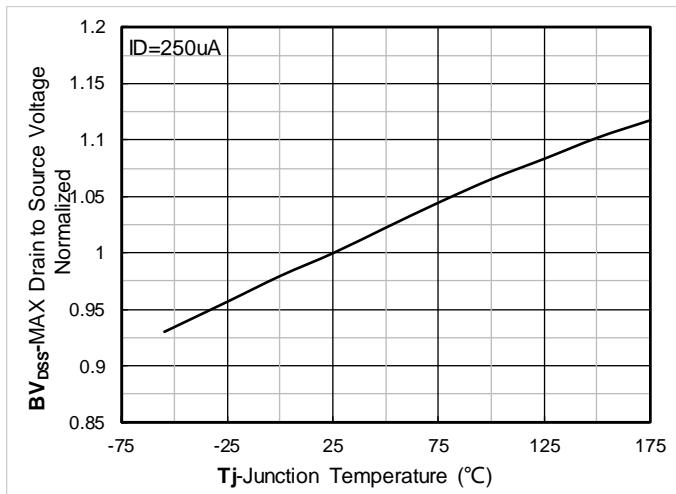


Figure 9. Normalized breakdown voltage

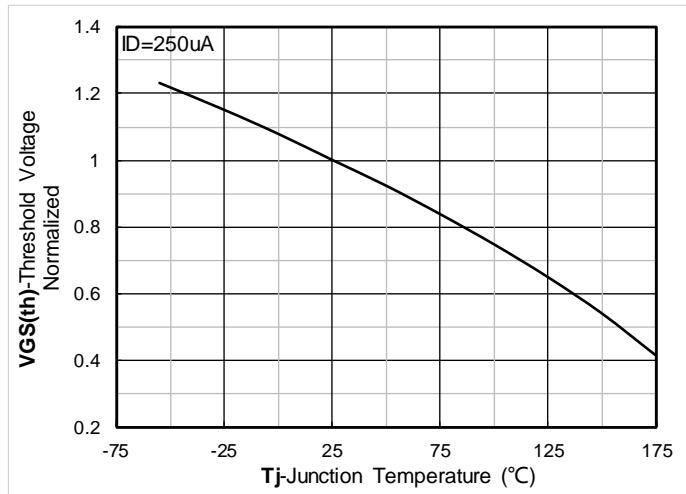


Figure 10. Normalized Threshold voltage

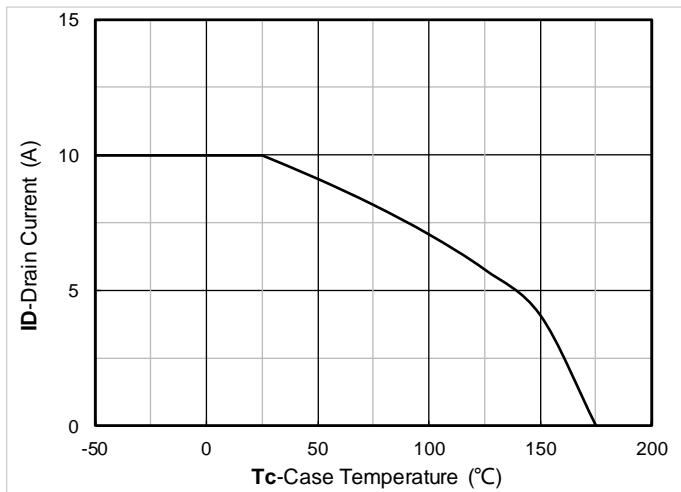


Figure 11. Current dissipation

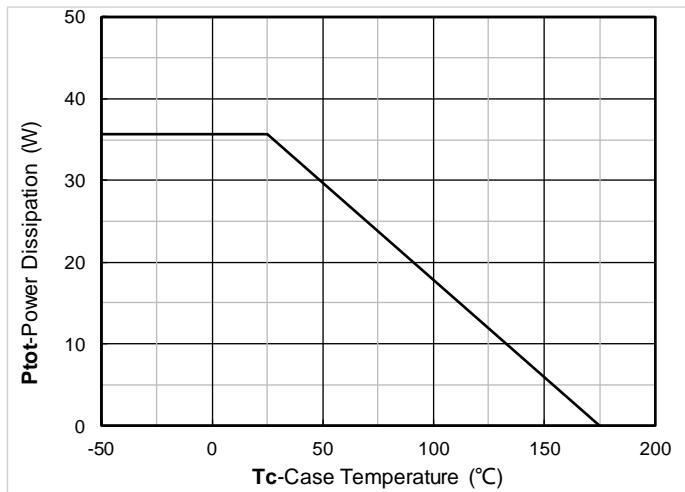


Figure 12. Power dissipation

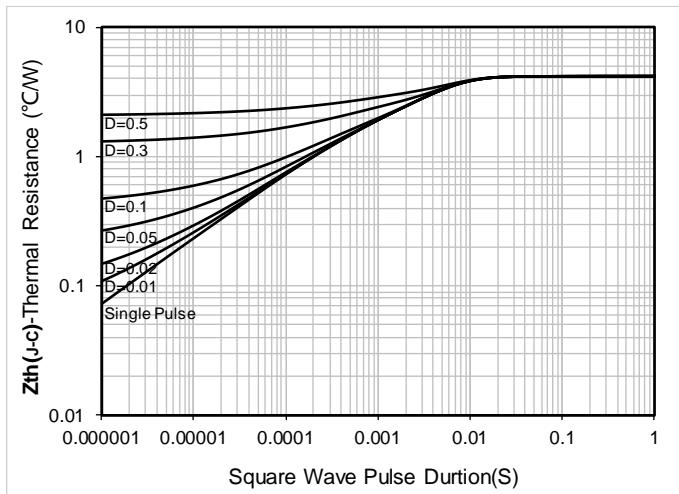


Figure 13. Maximum Transient Thermal Impedance

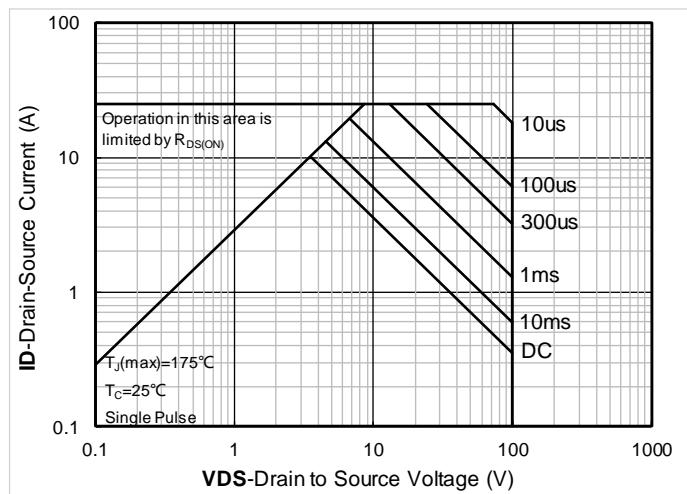


Figure 14. Safe Operation Area

■ Test Circuits & Waveforms

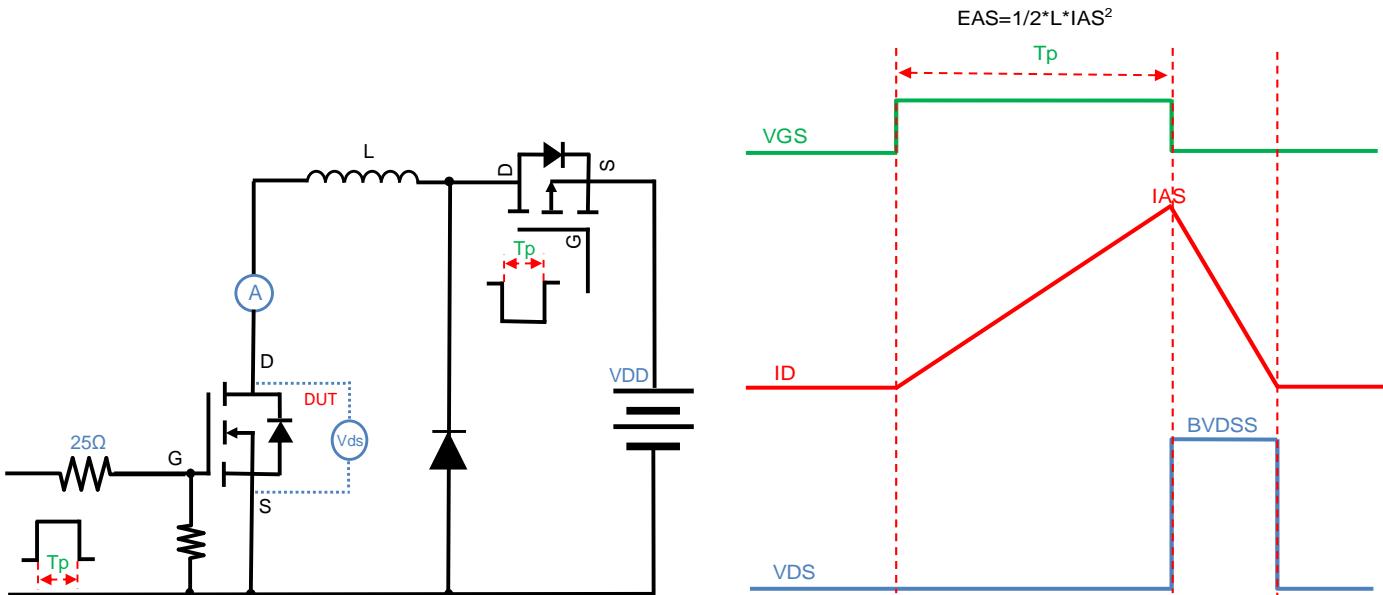


Figure A. Unclamped Inductive Switching (UIS) Test Circuit & Waveform

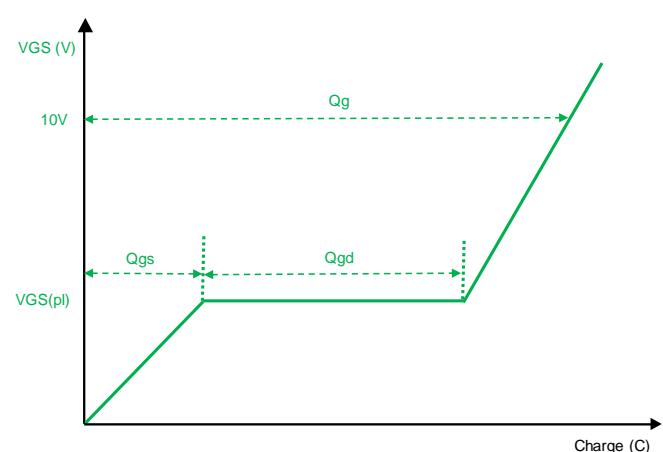
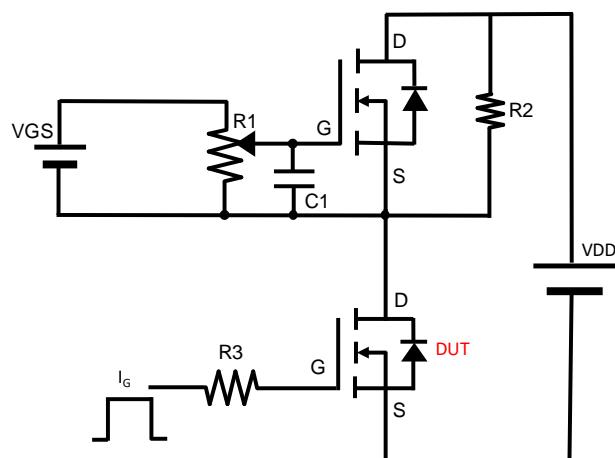


Figure B. Gate Charge Test Circuit & Waveform

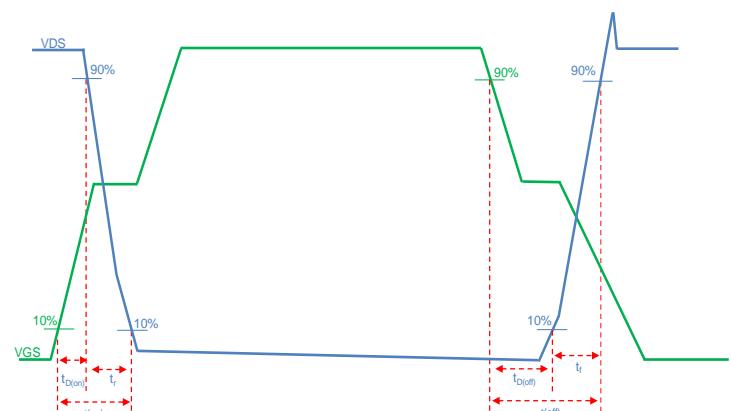
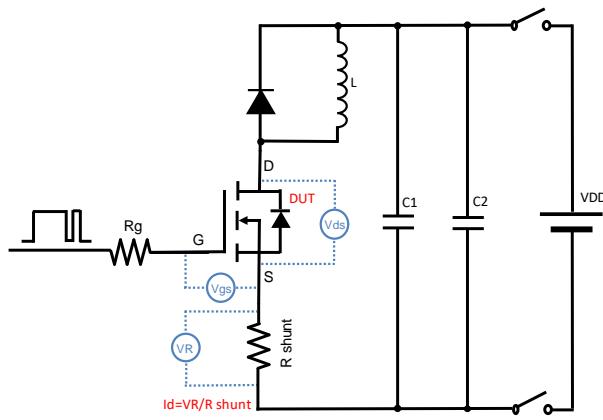


Figure C. Resistive Switching Test Circuit & Waveform

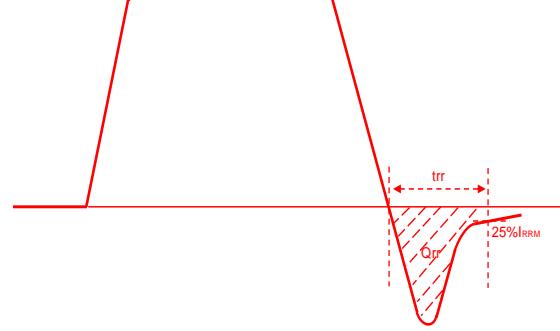
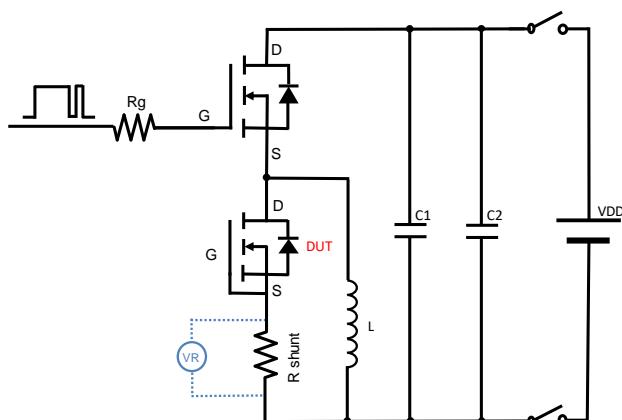
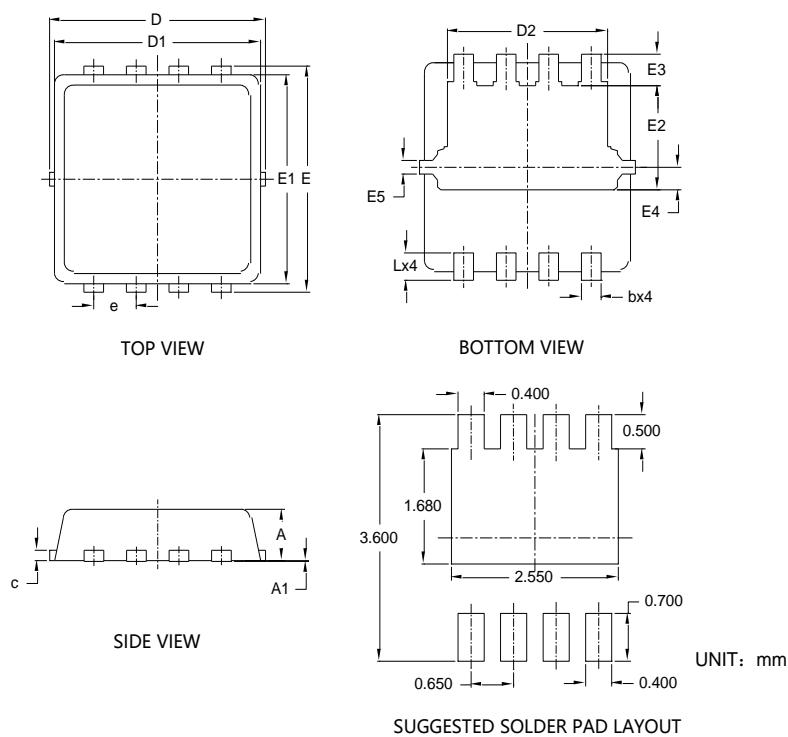


Figure D. Diode Recovery Test Circuit & Waveform

■ PDFN3333-8L-B-0.75mm Package information



| SYMBOL | DIMENSIONS | | | |
|--------|------------|-------|------------|-------|
| | INCHES | | Millimeter | |
| | MIN. | MAX. | MIN. | MAX. |
| A | 0.028 | 0.033 | 0.700 | 0.850 |
| A1 | 0.000 | 0.002 | 0.000 | 0.050 |
| b | 0.008 | 0.016 | 0.200 | 0.400 |
| c | 0.004 | 0.010 | 0.100 | 0.250 |
| D | 0.124 | 0.136 | 3.150 | 3.450 |
| D1 | 0.118 | 0.130 | 3.000 | 3.300 |
| D2 | 0.089 | 0.104 | 2.250 | 2.650 |
| E | 0.124 | 0.136 | 3.150 | 3.450 |
| E1 | 0.114 | 0.126 | 2.900 | 3.200 |
| E2 | 0.052 | 0.068 | 1.320 | 1.720 |
| E3 | 0.011 | 0.026 | 0.280 | 0.650 |
| E4 | 0.013 REF | | 0.330 REF | |
| E5 | 0.008 REF | | 0.200 REF | |
| e | 0.026 BSC | | 0.650 BSC | |
| L | 0.012 | 0.020 | 0.300 | 0.500 |

NOTE:

- 1.PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS.
- 2.TOLERANCE 0.1mm UNLESS OTHERWISE SPECIFIED.
- 3.THE PAD LAYOUT IS FOR REFERENCE PURPOSES ONLY.

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